



IFW

PATENT APPLICATION
Docket No. 9903-078
Client No. S02US013

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Young-Hee Song, et al. Conf. No. 9556
Serial No. 10/651,813 Examiner: Williams, Alexander O
Filed: August 28, 2003 Art Unit: 2826
For: SEMICONDUCTOR CHIP HAVING BOND PADS
AND MULTI-CHIP PACKAGE

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RESPONSE TO ELECTION REQUIREMENT

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to:
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Date: April 26, 2004


Adrienne Chocholak